





i envelope bearir	that this transmittal of the below on g Express Mail Postage and an x 1450 Alexandria, VA 22313-14	Express Mail label, with the b	deposited with the United States F elow serial number, addressed to t sit	ostal Service in an the Commissioner for	
Express Mail Label No.:		Name of Person Making the Deposit:	ANTHONY CHOU		
Date of Deposit:	02/27/04	Signature of the Person Making the Deposit:	anthous	1/2	
			Sty	$\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt$	
			Examiner: Mitchell, Ja Art Unit: 2827	<u>ames</u>	
Commission P.O. Box 14	atent Application ner for Patents 450 VA 22313-1450		AII OIIII. <u>2021</u>		
	<u>TRANSMI</u>	<u> TTAL OF FILING UNI</u>	DER 37 CFR 1.53(b)		
This is a req Application	uest for filing a Divisiona No. 10/113,526	al application under 37 filed on	CFR 1.53(b), of pending pr 03/28/02	rior application	
of Fr	ank Kuo				
for ENCAPSULATION METHOD AND LEADFRAME FOR LEADLESS SEMICONDUCTOR PACKAGES (AS AMENDED) Title of invention					
	Copy of Price	or Application as F	iled That is Attached		
х	A copy of the above ide filed is attached.	entified prior application	n, including the oath or dec	laration originally	
The copy of	the papers of prior applic	ation as filed which are	e attached are as follows:		
x x x x	6 page(s 1 page(s 1 page(s 3 sheet(s 2 page(s	s) of claims	ower of attorney		
			ired by 37 CFR 1.53(b), m tion showing applicant's si		
			iled to complete the prior a t introduce new matter the		

Amendments

X A preliminary Amendment is enclosed. (Claims added by this amendment have been properly numbered consecutively beginning with the number next following the highest numbered original claim in the prior application)
X A substitute specification incorporating all amendments filed in parent application is submitted herewith
Petition for Suspension of Prosecution for the Time Necessary to File an Amendment
There is provided herewith a Petition To Suspend Prosecution For The Time Necessary to File An Amendment (New Application Filed Concurrently).
Information Disclosure Statement
X An information disclosure statement is submitted herewith
Drawings
x Drawings are enclosed x formal informal
Priority Claim
35 U.S.C. 119 Priority of application Serial Number filed on in is claimed under 35 U.S.C. 119. The certified copy has been filed in prior U.S. application Serial No. in
35 U.S.C. 120, 121 and 365(c) "This application is a divisional and claims the benefit of copending application(s) application number 10/113,526 filed on 03/28/02 International Application filed on which designated the U.S."
Relate Back
Amend this specification by inserting, before the first line, the following sentence: "This is a x divisional of copending application(s)
X Application Number 10/113,526 filed on 03/28/02 International Application filed on which designated in the U.S."

page 2 of 5

Inventorship Statement

or application. It is requested that the following inventor(s) lication be deleted:
pplication are
on, including the ownership of the various claims at the as made, is submitted.
Assignment
of record to Siliconix Taiwan Ltd.
o Sheet for Assignment (Document) Accompanying New 1595 is also Attached.
ver of Attorney
r application is to
Registration No.: 36,398
Registration No.: 35,295
Registration No.: 35,398
Registration No.: 42,293
Registration No.: 46,434
Registration No.: 43,628
Registration No.: 46,274
Registration No.: 46,315
Registration No.: 43,009
Registration No.: 47,050
Registration No.: 46,558
Registration No.: 45,927
Registration No.: 48,098
Registration No.: 46,120
Registration No.: 46,127
Registration No.: 52,389
Registration No.: 52,992

 a. X b. Because the power does not appear in the original papers, a copy of the power in the prior application is enclosed. c. A new power has been executed and is attached.
Maintenance of Codependency of Prior Application
A petition, fee and response has been filed to extend the term pending prior application until
A copy of the petition for extension of time in the prior application is attached.
Conditional Petition for Extension of Time in Prior Application
A conditional petition for extension of time is being filed in the pending parent application. A copy of the conditional petition for extension of time in the prior application is attached
Abandonment of Prior Application (if applicable)
Please abandon the prior application at a time while the prior application is pending or when the petition for extension of time or to revive in that application is granted and when this application is granted a filing date so as to make this application copending with said prior application.
Notification in Parent Application of the Filing of This Divisional Application
A notification of the filing of this divisional is being filed in the parent application from which this application claims priority under 35 USC § 120.
Statement by Assignee (if applicable)
In accordance with 37 CFR 3.73, I have reviewed the evidentiary documents establishing my/our ownership of the application identified herein, and certify that to the best of my/our knowledge and belief, title is with me/us who seek to take action. Assignment submitted herewith for recordal
I hereby declare further that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.
Type or print name of person signing declaration
Signature Date Residence Citizenship
P.O. Addroop
(type name of assignee) Title of person authorized to sign on behalf of assignee
Address of Assignee
Assignment recorded in PTO on Reel Frame
The statement under 37 CFR 3.73(b)

page 4 of 5 rev. 4/02 kgr

has been filed in the parent application.
a copy of the statement previously filed in the parent application is attached.

Fee Calculation

	C 18 18-	CLAIMS A	AS FILED		. 4
	NO. OF CLAIMS		EXTRA CLAIMS	RATE	FEES
Basic Application Fee			\$770.00		
Total Claims	3	Minus 20=	0	X \$18 =	\$0.00
Independent Claims	1	Minus 3=	0	X \$86=	\$0.00
If multiple dependent claims are presented, add \$290.00				\$0.00	
TOTAL APPLICATION FEE DUE				\$770.00	

PAYMENT OF FEES

- 1. The full fee due in connection with this communication is provided as follows:
- [x] The Commissioner is hereby authorized to charge any additional fees associated with this communication or credit any overpayment to Deposit Account No.: 23-0085.

 A duplicate copy of this authorization is enclosed.
- [X] A check in the amount of \$770.00

[] Charge any fees required or credit any overpayments associated with this filing to Deposit Account No.: 23-0085.

Please direct all correspondence concerning the above-identified application to the following address:

WAGNER, MURABITO & HAO LLP

Two North Market Street, Third Floor San Jose, California 95113 (408) 938-9060

Respectfully submitted,

Date: Convay 27, 2004

Reg. No. 46,274

Docket No.: VISH-4123 <u>Patent</u>

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Kuo)
Serial No.: 10/113,526
Filing Date: 03/28/02
For ENCAPSULATION METHOD AND) LEADFRAME OF LEADLESS SEMICONDUCTOR) PACKAGE
CERTIFICATE UNDER 37 CFR 3.73(b)
SILICONIX TAIWAN LTD., a corporation, certifies that it is the assignee of the entire right, title and interest in the patent application identified above by virtue of either: [X] An assignment from the inventor(s) of the patent application identified above. A copy of the assignment is attached.
[] A chain of title from the inventor(s), of the patent application identified above, to the current assignees as shown below:
1. From: To:
2. From: To:
3. From: To:
[] Additional documents in the chain of title are listed on a

[] Copies of assignments or other documents in the chain of title are attached.

supplemental sheet.

The undersigned has reviewed all the documents in the chain of title of the patent application identified above and, to the best of undersigned's knowledge and belief, title is in the assignee identified above.

The undersigned (whose title is supplied below) avers that the undersigned is empowered to sign this certificate on behalf of the assignee.

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements are made with the knowledge that willful false statements, and the like so made, are punishable by fine or imprisonment, or both, under Section 1001, Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date

Signature

Dr. King Owyang Typed or Printed Name

President and CEO Title

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Docket No.: VISH-4123 Thereby certify that this transmittal of the below described document is being deposited with the United States Postal Service in an envelope bearing First Class Postage and addressed to the Assistant Commissioner for Patents, Washington, D.C., 20231, on the below date of deposit.

Date of Deposit:

| Date of Deposit: | Name of Person Making the Deposit: | KATHERINE RINALDI | Signature of the Person Making the Deposit: | Washington | Commissioner for Patents, Washington | Commissio In re Application Inventor(s): Frank Kuo Application No.: 10/113,526 Filed: 03/28/02 Title: ENCAPSULATION METHOD AND LEADFRAME FOR LEADLESS SEMICONDUCTOR PACKAGES (AS AMENDED) **Commissioner for Patents** P.O. Box 1450 22313-1450 Alexandria, VA NOTIFICATION OF FILING OF DIVISIONAL APPLICATION x Notification is hereby being made of the filing of a divisional application for this case concurrently herewith. Please direct all correspondence concerning the above-identified application to the following address: WAGNER, MURABITO & HAO LLP Two North Market Street, Third Floor San Jose, California 95113 (408) 938-9060 Respectfully submitted, Date: Vebruary 27 2004

Page 1 of 1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Docket No.: VISH-4123 Thereby certify that this transmittal of the below described document is being deposited with the United States Postal Service in an envelope bearing First Class Postage and addressed to the Assistant Commissioner for Patents, Washington, D.C., 20231, on the below date of deposit.

Date of Deposit: 02/27/04 Name of Person Making the Deposit: KATHERINE RINALDI Signature of the Person Making the Deposit: Washington, D.C., 20231, on the below date of deposit. In re Application of: Inventor(s): Frank Kuo Application No.: 10/113,526 Filed: 03/28/02 Title: ENCAPSULATION METHOD AND LEADFRAME FOR LEADLESS SEMICONDUCTOR PACKAGES (AS AMENDED) **Commissioner for Patents** P.O. Box 1450 Alexandria, VA 22313-1450 CONDITIONAL PETITION FOR EXTENSION OF TIME This conditional petition is being filed along with the DIVISIONAL accompanying and provides for the possibility that applicant has inadvertently overlooked the need for a petition and fee for extension of time. Conditional petition for extension of time If any extension of time for the accompanying response is required, applicant requests that this be considered a petition therefore. Status This application is on behalf of other than a small entity a small entity A verified statement: is attached is already filed The Commissioner is hereby authorized to charge any additional fees associated with this

communication or credit any overpayment to Deposit Account No.: 23-0085.

A duplicate copy of this authorization is enclosed.

Please direct all correspondence concerning the above-identified application to the following address:

WAGNER, MURABITO & HAO LLP

Two North Market Street, Third Floor San Jose, California 95113 (408) 938-9060

Respectfully submitted,

Date: February 27, 2001

Éric J. Gash

Reg. No. 46,274

Notification to Parent of Divisional Application Filing Applicant: F. Kuo Filing Date: 03/28

Docket No.: VISH-4123 Serial No.:10/113

Filing Date: 03/28/02

Serial No.:10/113,526

Title: ENCAPSULATION METHOD AND LEADFRAME FOR

LEADLESS SEMICONDUCTOR PACKAGES (AS AMENDED)

Please acknowledge receipt of the following:

Certificate of Mailing
Conditional Petition for an Extension of Time
Notification of Filing of Divisional Application

rev. 12/97 dbp

Submitted 2/27/04

Attorney Docket No.: VISH-4123.DIV

Inventor(s):

Frank Kuo

Title:

ENCAPSULATION METHOD AND LEADFRAME FOR LEADLESS SEMICONDUCTOR

PACKAGES

REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

Date: February 27, 2004

Reg. No. 46,274

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).